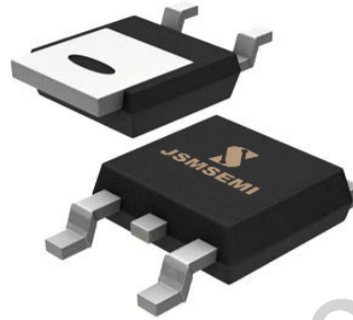


Features

- 40V/50A,
 $R_{DS(ON)}=7.2m\Omega$ (Typ.)@ $V_{GS}=10V$
 $R_{DS(ON)}=9.2m\Omega$ (Typ.)@ $V_{GS}=4.5V$
- Reliable and Rugged
- Lead Free and Green Devices Available
 (RoHSCompliant)



Applications

- Power Management in Desktop Computer or
 DC/DC Converters.

Pin Description

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
Common Ratings ($T_A=25^\circ\text{C}$ Unless Otherwise Noted)				
V_{DSS}	Drain-Source Voltage	40	V	
$BV_{DS(Avalanche)}^*$	Drain-Source Avalanche Voltage (Maximum)	45		
V_{GSS}	Gate-Source Voltage	± 20		
T_J	Maximum Junction Temperature	175	$^\circ\text{C}$	
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ\text{C}$	
I_S	Diode Continuous Forward Current	40	A	
I_{DP}	300 μs Pulse Drain Current Tested	$T_C=25^\circ\text{C}$	160	A
		$T_C=100^\circ\text{C}$	90	
I_D	Continuous Drain Current	$T_C=25^\circ\text{C}$	60***	A
		$T_C=100^\circ\text{C}$	48	
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	60	W
		$T_C=100^\circ\text{C}$	30	
$R_{\theta JC}$	Thermal Resistance-Junction to Case	2.5	$^\circ\text{C/W}$	
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	50	$^\circ\text{C/W}$	
E_{AS}^{**}	Drain-Source Avalanche Energy	L=0.5mH	100	mJ

Notes :

* Avalanche single pulse test and avalanche period time $t_{av} \leq 100 \mu\text{s}$, duty < 1% .

** Avalanche test condition: $T_J=25^\circ\text{C}$, L=0.5mH, $I_{AS}=20\text{A}$, $V_{DD}=30\text{V}$, and $V_{GS}=10\text{V}$.

*** Current limited by bond wire.

Electrical Characteristics (Cont.) ($T_A = 25^\circ\text{C}$ unless otherwise noted)

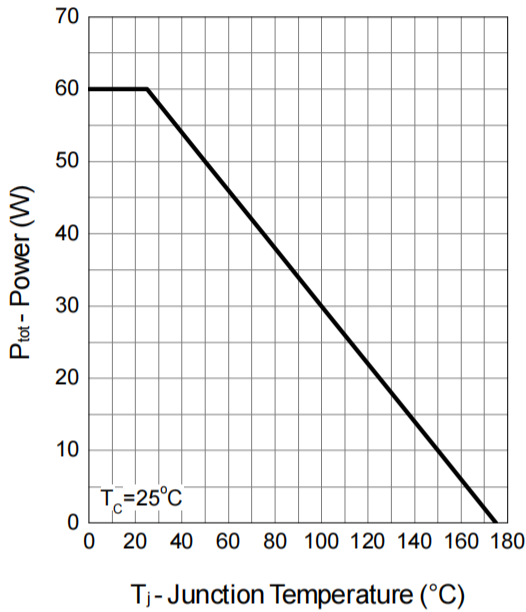
Symbol	Parameter	Test Conditions	4184			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=40V, V_{GS}=0V$	-	-	1	μA
		$T_J=85^\circ C$	-	-	30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	1.2	1.6	2	V
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
$R_{DS(on)}^a$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=20A$	-	7.2	9	m Ω
		$V_{GS}=4.5V, I_{DS}=10A$	-	9.2	13	
Diode Characteristics						
V_{SD}^a	Diode Forward Voltage	$I_{SD}=20A, V_{GS}=0V$	-	0.8	1.1	V
t_r	Reverse Recovery Time	$I_{DS}=40A,$ $di_{SD}/dt=100A/\mu s$	-	28	-	ns
Q_{rr}	Reverse Recovery Charge		-	24	-	nC
Dynamic Characteristics^b						
R_G	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1MHz$	-	1.4	-	Ω
C_{iss}	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=20V,$ Frequency=1.0MHz	-	1460	-	pF
C_{oss}	Output Capacitance		-	180	-	
C_{riss}	Reverse Transfer Capacitance		-	146	-	
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=20V, R_L=20\Omega,$ $I_{DS}=1A, V_{GEN}=10V,$ $R_G=6\Omega$	-	11	21	ns
t_r	Turn-on Rise Time		-	13	24	
$t_{d(OFF)}$	Turn-off Delay Time		-	37	67	
t_f	Turn-off Fall Time		-	11	21	
Gate Charge Characteristics^b						
Q_g	Total Gate Charge	$V_{DS}=20V, V_{GS}=10V,$ $I_{DS}=40A$	-	31.2	44	nC
Q_{gs}	Gate-Source Charge		-	3.8	-	
Q_{gd}	Gate-Drain Charge		-	9	-	

 Note a : Pulse test ; pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

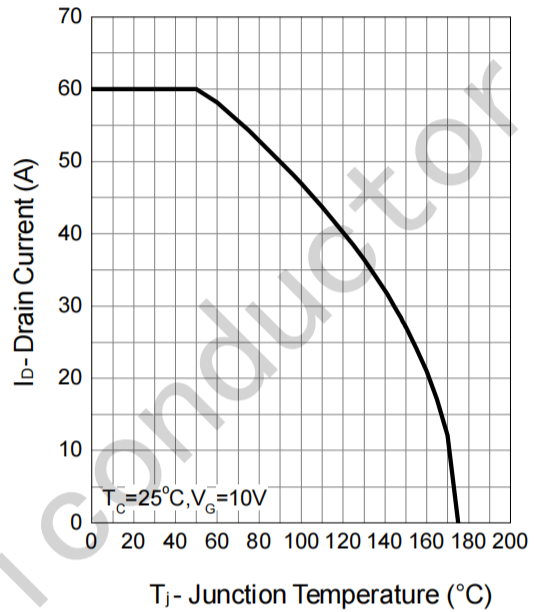
Note b : Guaranteed by design, not subject to production testing.

Typical Operating Characteristics

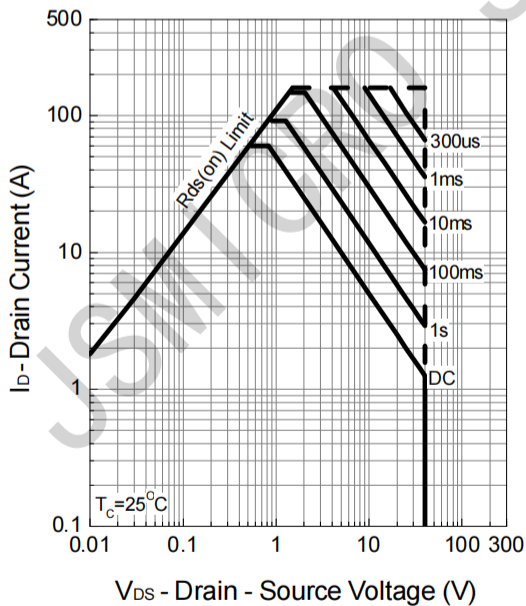
Power Dissipation



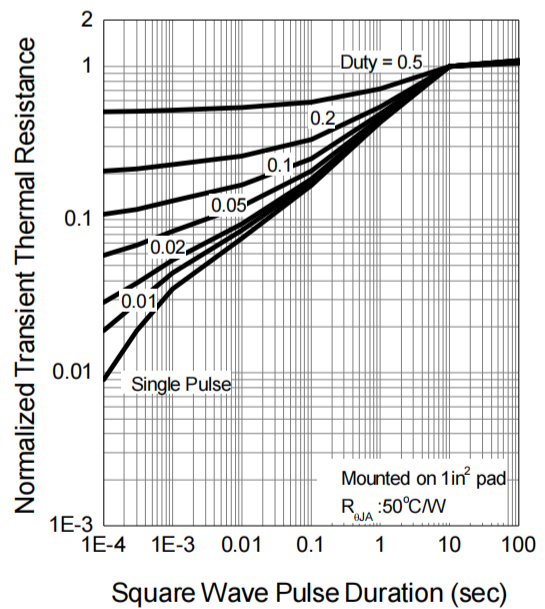
Drain Current



Safe Operation Area

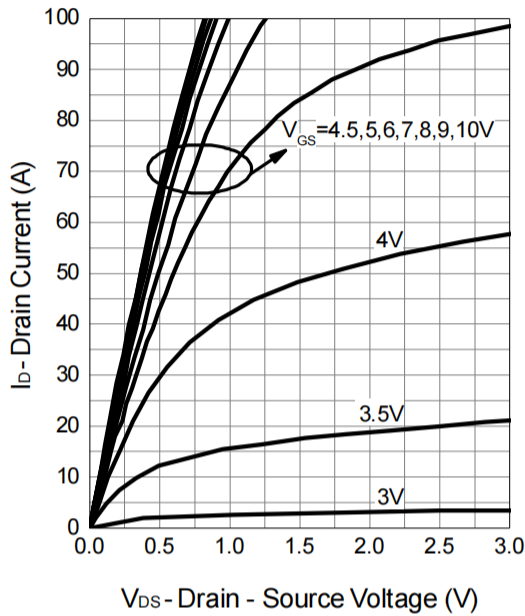


Thermal Transient Impedance

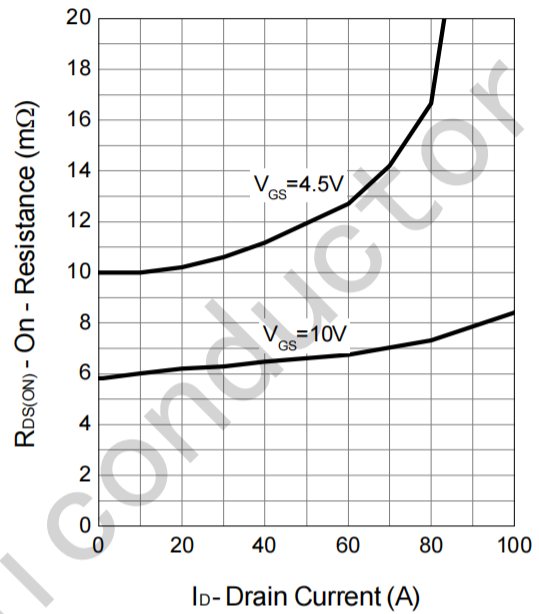


Typical Operating Characteristics(Cont.)

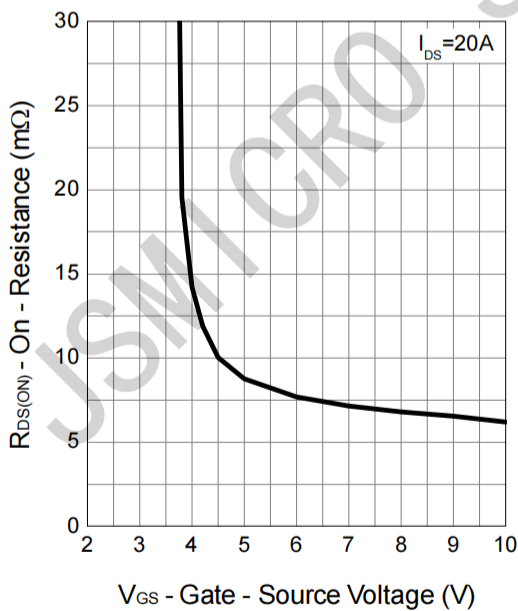
Output Characteristics



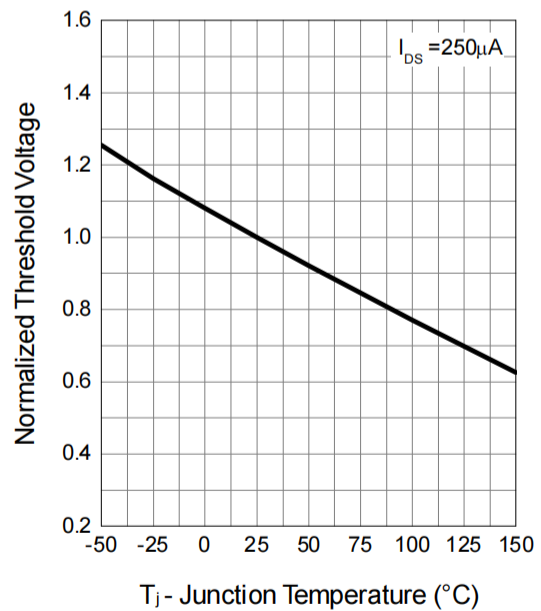
Drain-Source On Resistance



Gate-Source On Resistance

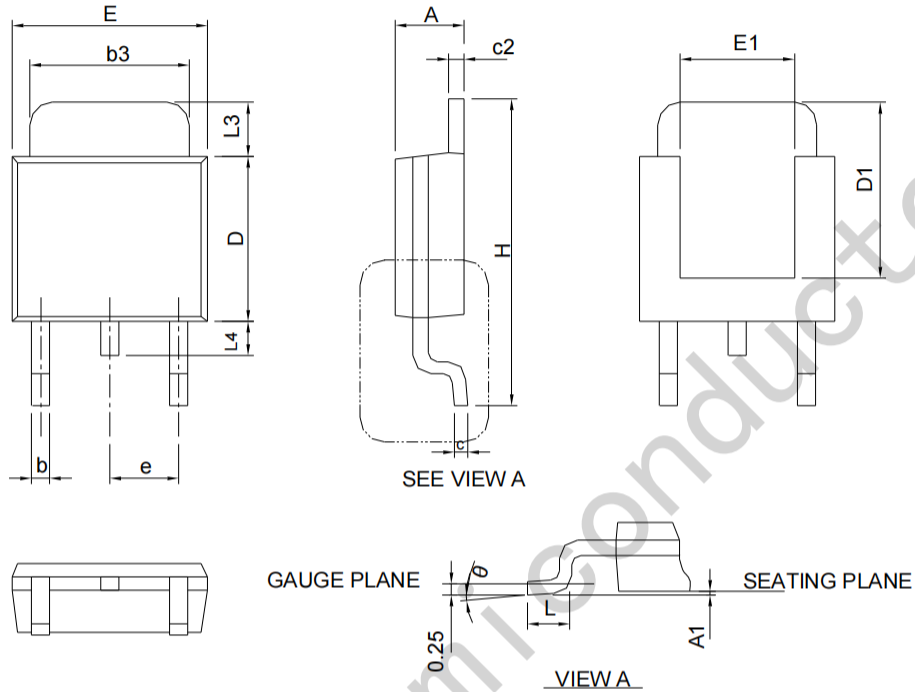


Gate Threshold Voltage



Package Information

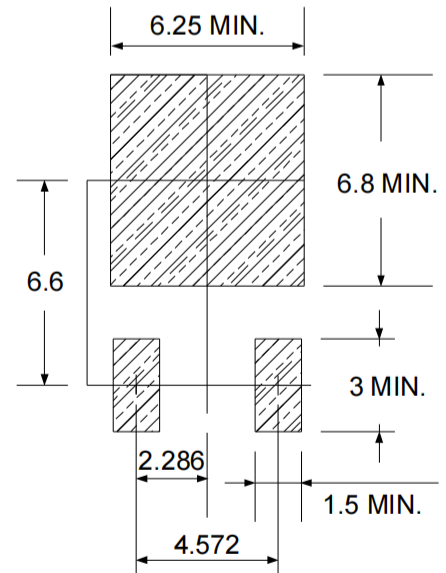
TO-252-2



SYMBOL	TO-252			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.18	2.39	0.086	0.094
A1	-	0.13	-	0.005
b	0.50	0.89	0.020	0.035
b3	4.95	5.46	0.195	0.215
c	0.46	0.61	0.018	0.024
c2	0.46	0.89	0.018	0.035
D	5.33	6.22	0.210	0.245
D1	4.57	6.00	0.180	0.236
E	6.35	6.73	0.250	0.265
E1	3.81	6.00	0.150	0.236
e	2.29 BSC		0.090 BSC	
H	9.40	10.41	0.370	0.410
L	0.90	1.78	0.035	0.070
L3	0.89	2.03	0.035	0.080
L4	-	1.02	-	0.040
θ	0°	8°	0°	8°

Note : Follow JEDEC TO-252 .

RECOMMENDED LAND PATTERN



UNIT: mm

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